



### **4 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY**

## **Product Summary**

V <sub>BR (min)</sub>	I <sub>PP (max)</sub>	C <sub>T (typ)</sub>
6V	5.5A	0.55pF

### **Description**

The DT1240V3-04LP-7 is a high-performance device suitable for protecting four high speed I/Os. These devices are assembled in DFN2510-10 packages and have high ESD surge capability and low capacitance.

## **Applications**

Typically used at high-speed ports such as USB 2.0, IEEE1394 (Firewire®, iLink™), Serial ATA, DVI, HDMI, PCI.

### **Features**

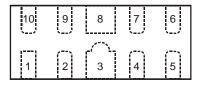
- Clamping Voltage: 8.8V at 10A 100ns, TLP9V at 5.5A 8µs/20µs
- IEC 61000-4-2 (ESD): Air ±16kV, Contact ±14kV
- IEC 61000-4-5 (Lightning): ±5.5A (8/20µs)
- 4 Channels of ESD protection
- Low Channel Input Capacitance of 0.55pF Typical
- TLP Dynamic Resistance: 0.3Ω
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

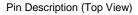
### **Mechanical Data**

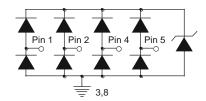
- Case: U-DFN2510-10
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Schematic
- Terminals: Finish NiPdAu, Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.038 grams (Approximate)

### U-DFN2510-10

Pin#	Description
1, 2, 4, 5	I/O
6, 7, 9, 10	No Connection
3, 8	$V_{ss}$







Device Schematic

### **Ordering Information** (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DT1240V3-04LP-7	Standard	BE7	7	8	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**

U-DFN2510-10

BE7 YM

BE7 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key

Date Code Ney						
Year	2013	2014	2015	2016	2017	2018
Code	Α	В	С	D	Е	F

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current, per IEC 61000-4-5	I <sub>PP</sub>	5.5	Α	I/O to V <sub>SS</sub> , 8/20µs
Peak Pulse Power, per IEC 61000-4-5	P <sub>PP</sub>	60	W	I/O to V <sub>SS</sub> , 8/20µs
ESD Protection – Contact Discharge, per IEC 61000-4-2	V <sub>ESD_Contact</sub>	±14	kV	I/O to V <sub>SS</sub>
ESD Protection – Air Discharge, per IEC 61000-4-2	$V_{ESD\_Air}$	±16	kV	I/O to V <sub>SS</sub>
Operating Temperature	T <sub>OP</sub>	-55 to +85	°C	_
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C	_

## **Thermal Characteristics**

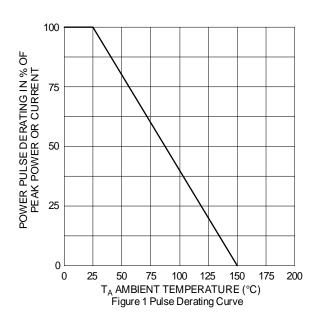
Characteristic	Symbol	Value	Unit
Power Dissipation Typical (Note 5)	$P_{D}$	350	mW
Thermal Resistance, Junction to Ambient Typical (Note 5)	$R_{ hetaJA}$	360	°C/W

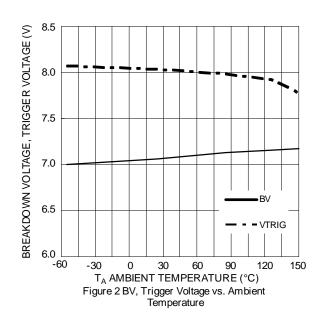
## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	$V_{RWM}$	_	_	3.3	V	I <sub>R</sub> =1mA, , I/O to V <sub>SS</sub>
Reverse Current	I <sub>R</sub>	_	_	0.5	μΑ	$V_R = 3.3V$ , I/O to $V_{SS}$
Reverse Breakdown Voltage	$V_{BR}$	6	-	_	V	$I_R = 1$ mA, I/O to $V_{SS}$
Forward Clamping Voltage	$V_{F}$	-1.0	-0.85	_	V	$I_F$ = -15mA, I/O to $V_{SS}$
Reverse Clamping Voltage (Note 6)	V <sub>C</sub>	_	9	11	V	$I_{PP} = 5.5A$ , I/O to $V_{SS}$ , 8/20 $\mu$ s
Trigger Voltage	V <sub>TRIG</sub>	_	_	9.5	V	_
ESD Clamping Voltage	V <sub>ESD</sub>	_	8.8	_	V	TLP, 10A, tp = 100 ns, I/O to V <sub>SS</sub>
Dynamic Reverse Resistance	R <sub>DIF-R</sub>	_	0.3	_	Ω	TLP, 10A, tp = 100 ns, I/O to $V_{SS}$
Dynamic Forward Resistance	R <sub>DIF-F</sub>	_	0.25	_	Ω	TLP, 10A, tp = 100 ns, $V_{SS}$ to I/O
Channel Input Capacitance (Note7)	C <sub>I/O</sub>	_	0.55	0.65	pF	$V_{I/O} = 2.5V$ , $V_{SS} = 0V$ , $f = 1MHz$
Delta C <sub>I/O</sub>	CI/OMAX-CI/OMIN	_	0.04	_	pF	C <sub>I/OMAX</sub> -C <sub>I/OMIN</sub>

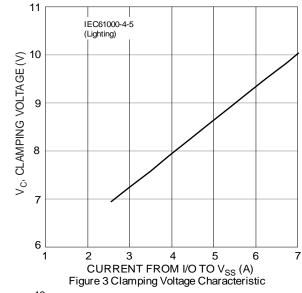
Notes:

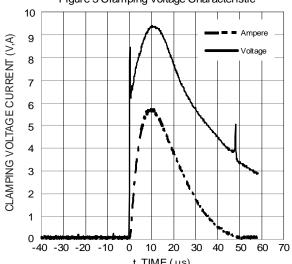
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Clamping voltage value is based on an  $8x20\mu s$  peak pulse current ( $I_{pp}$ ) waveform.
- $7.\ C_{I/O1} = C_{PIN1} + C_{PIN10},\ C_{I/O2} = C_{PIN2} + C_{PIN9},\ C_{I/O3} = C_{PIN4} + C_{PIN7},\ C_{I/O4} = C_{PIN5} + C_{PIN6},\ C_{I/O3} = C_{PIN6} + C_{PIN7},\ C_{I/O4} = C_{PIN5} + C_{PIN6}$



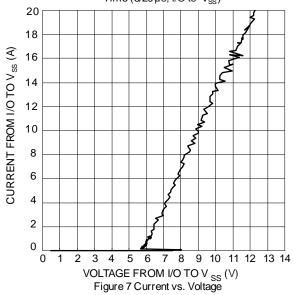


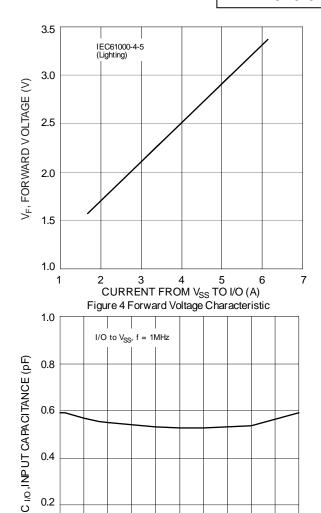






t, TIME (  $\mu s)$  Figure 5 Waveform of Clamping Voltage, Current vs. Time (8/20  $\mu$ s, I/O to  $V_{SS}$ )





 $V_{I/O}$ , INPUT VOLTAGE ( V) Figure 6 Input Capacitance vs. Input Voltage

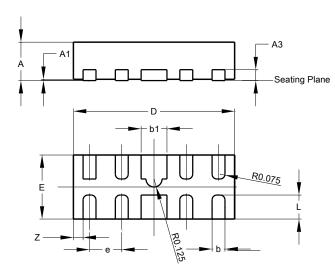
1.0 1.5 2.0 2.5 3.0 3.5 4.0 4.5 5.0

0.2



## **Package Outline Dimensions**

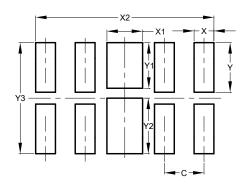
Please see AP02001 at http://www.diodes.com/\_files/datasheets/ap02001.pdf for the latest version.



U-DFN2510-10							
Dim	Min	Max	Тур				
Α	0.545	0.605	0.575				
<b>A</b> 1	0	0.05	0.03				
A3	-	-	0.13				
b	0.15	0.25	0.20				
b1	035	0.45	0.40				
D	2.450	2.575	2.500				
е	-	-	0.50				
Е	0.950	1.075	1.000				
L	0.325	0.425	0.375				
Z	-	-	0.150				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/\_files/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.500
Х	0.250
X1	0.450
X2	2.250
Y	0.625
Y1	0.575
Y2	0.700
Y3	1.400



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